Data sheet acquired from Harris Semiconductor CD4585B Types
SCHS091B - Revised July 2003

## CMOS 4-Bit Magnitude Comparator

High Voltage Types (20-Volt Rating)

- CD4585B is a 4-bit magnitude comparator designed for use in computer and logic applicationts that require the comparison of two 4 -bit words. This logic circuit determines whether one 4-bit word (Binary or $B C D$ ) is "less than", "equal to", or "greater than" a second 4-bit word.
The CD4585B has eight comparing inputs (A3, B3, through AO; B0), three outputs ( $A$ $\langle B, A=B, A>B$ ) and three cascading tinputs $(A<B, A=B, A>B)$ that permit systems designers to expand the comparator function to $8,12,16 \ldots . . . .4 \mathrm{~N}$ bits. When a single CD4585B is used, the cascading inputs are connected as follows: $(A<B)=$ low, $(A=B)$ $=$ high, $(A>B)=$ high.
Cascading these units for comparison of more than 4 bits is accomplished as shown in Fig. 13.
The CD4585B types are supplied in 16 -lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages ( E suffix), 16 -lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).


## Features:

- Expansion to 8,12,16......4N bits by cascading units
- Medium-speed operation: compares two 4-bit words in 180 ns (typ.) at 10 V
- 100\% tested for quiescent current at 20 V
m Standardized symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of $1 \mu \mathrm{~A}$ at 18 V over full package temperature range;
100 nA at 18 V and $25^{\circ} \mathrm{C}$
- Noise margin (full package temperature range)

$$
\begin{aligned}
\text { range }= & 1 \mathrm{~V} \text { at } \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V} \\
& 2 \mathrm{~V} \text { at } V_{D D}=10 \mathrm{~V} \\
& 2.5 \mathrm{~V} \text { at } V_{D D}=15 \mathrm{~V}
\end{aligned}
$$

- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of ' $B$ ' Series CMOS Devices"


## Applications:

- Servo motor controls - Process controllers

MAXIMUM RATINGS, Absolute-Maximum Values: DC SUPPLY-VOLTAGE RANGE, (VDD)
Voltages referenced to $V_{S S}$ Terminal) $-0.5 V$ to $+20 V$
$\qquad$ DC INPUT CURRENT, ANY ONE INPUT . .......................................................................................... POWER DISSIPATION PER PACKAGE (PD):

$$
\text { For } T_{A}=-55^{\circ} \mathrm{C} \text { to }+100^{\circ} \mathrm{C}
$$

$\qquad$
For $\mathrm{T}_{A}=+100^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$. $\qquad$ .................. . 500 mW DEVICE DISSIPATION PER OUTPUT TRANSISTOR
FOR $T_{A}=$ FULL PACKAGE-TEMPERATURE RANGE (All Package Types) . . . . . . . . . . . . . . . . . . . . . . . . . 100 mW


LEAD TEMPERATURE (DURING SOLDERING):
At distance $1 / 16 \pm 1 / 32$ inch ( $1.59 \pm 0.79 \mathrm{~mm}$ ) from case for 10 s max
$+265^{\circ} \mathrm{C}$

## RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominat operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: |
|  | Min. | Max. |  |



Fig. 1 - Typical output low (sink) current characteristics.


Fig. 2 - Minimum output low (sink) current characteristics.


Fig. 3 - Typical output high (source) current characteristics.

## CD4585B Types




Fig. 5 - Minimum oütput high (source) current characteristics.


Fig. 6 - Typical transition time as a function of load capacitance.


Fig. 7 - Typical propagation delay time ("comparing inputs" to outputs) as a function of load capacitance.

STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC | CONDITIONS |  |  | LIMITS AT INDICATED TEMPERATURES ( ${ }^{\circ} \mathrm{C}$ ) |  |  |  |  |  |  | $\left.\begin{array}{l}U \\ N \\ 1 \\ T \\ S\end{array}\right]$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $V_{0}$ <br> (V) | VIN (V) | $\begin{array}{\|} \mathbf{V}_{\mathbf{D D}} \\ \mathbf{( V )} \end{array}$ | -55 | -40 | +85 | +125 | +25 |  |  |  |
|  |  |  |  |  |  |  |  | Min. | Typ. | Max. |  |
| Quiescent Device Current, 'DD Max. | - | 0,5 | 5 | 5 | 5 | 150 | 150 | - | 0.04 | 5 | $\mu A$ |
|  | - | 0,10 | 10 | 10 | 10 | 300 | 300 | - | 0.04 | 10 |  |
|  | - | 0,15 | 15 | 20 | 20 | 600 | 600 | - | 0.04 | 20 |  |
|  | - | 0,20 | 20 | 100 | 100 | 3000 | 3000 | - | 0.08 | 100 |  |
| Output Low (Sink) Current ${ }^{\prime}$ OL Min. | 0.4 | 0,5 | 5 | 0.64 | 0.61 | 0.42 | 0.36 | 0.51 | 1 | - | mA |
|  | 0.5 | 0,10 | 10 | 1.6 | 1.5 | 1.1 | 0.9 | 1.3 | 2.6 | - |  |
|  | 1.5 | 0,15 | 15 | 4.2 | 4 | 2.8 | 2.4 | 3.4 | 6.8 | - |  |
| Output High (Source) Current, ${ }^{\prime} \mathrm{OH}^{\text {Min. }}$ | 4.6 | 0,5 | 5 | -0.64 | -0.61 | -0.42 | -0.36 | -0.51 | -1 | - |  |
|  | 2.5 | 0,5 | 5 | -2 | -1.8 | -1.3 | -1.15 | -1.6 | -3.2 | - |  |
|  | 9.5 | 0,10 | 10 | -1.6 | -1.5 | -1.1 | -0.9 | -1.3 | -2.6 | - |  |
|  | 13.5 | 0,15 | 15 | -4.2 | -4 | -2.8 | -2.4 | $-3.4$ | -6.8 | - |  |
| Output Voltage: Low-Level, VOL Max. | - | 0,5 | 5 | 0.05 |  |  |  | - | 0 | 0.05 | $V$ |
|  | - | 0,10 | 10 | 0.05 |  |  |  | - | 0 | 0.05 |  |
|  | - | 0,15 | 15 | 0.05 |  |  |  | - | 0 | 0.05 |  |
| Output Voltage: High-Level, $\mathrm{V}_{\mathrm{OH}}$ Min. | - | 0,5 | 5 | 4.95 |  |  |  | 4.95 | 5 | - |  |
|  | - | 0,10 | 10 | 9.95 |  |  |  | 9.95 | 10 | - |  |
|  | - | 0.15 | 15 | 14.95 |  |  |  | 14.95 | 15 | - |  |
| Input Low Voltage VIL Max. | 0.5,4.5 | - | 5 | 1.5 |  |  |  | - | - | 1.5 | $V$ |
|  | 1,9 | - | 10 | 3 |  |  |  | - | - | 3 |  |
|  | 1.5,13.5 | - | 15 | 4 |  |  |  | - | - | 4 |  |
| Input High Voltage, $V_{\text {IH }}$ Min. | 0.5,4.5 | - | 5 | 3.5 |  |  |  | 3.5 | - | - |  |
|  | 1,9 | - | 10 | 7 |  |  |  | 7 | - | - |  |
|  | 1.5,13.5 | - | 75 | 11 |  |  |  | 11 | - | - |  |
| Input Current IIN Max. | - | 0,18 | 18 | $\pm 0.1$ | $\pm 0.1$ | $\pm 1$ | $\pm 1$ | - | $\pm 10^{-5}$ | $\pm 0.1$ | $\mu \mathrm{A}$ |

## DYNAMIC ELECTRICAL CHARACTERISTICS

At $T_{A}=25^{\circ} \mathrm{C}$; input $t_{r}, t_{f}=20 \mathrm{~ns}, C_{L}=50 \mathrm{pF}, R_{L}=200 \mathrm{k} \Omega$

| CHARACTERISTIC | TEST CONDITIONS | $\begin{aligned} & \text { Vod } \\ & \text { Volts } \end{aligned}$ | LIMITS |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Typ. | Max. |  |
| Propagation Delay Time: Comparing Inputs to Outputs, tPHL, tPLH |  | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\begin{array}{r} 300 \\ 125 \\ 80 \\ \hline \end{array}$ | $\begin{aligned} & \hline 600 \\ & 250 \\ & 160 \\ & \hline \end{aligned}$ | ns |
| Cascading Inputs to Outputs, tphL, tPLH |  | $\begin{array}{r} 5 \\ 10 \\ 15 \end{array}$ | $\begin{array}{r} 200 \\ 80 \\ 60 \\ \hline \end{array}$ | $\begin{aligned} & \hline 400 \\ & 160 \\ & 120 \end{aligned}$ |  |
| Transition Time, ${ }^{\text {t THL }}$. ${ }^{\text {TLLH }}$ |  | $\begin{array}{r} 5 \\ 10 \\ 15 \\ \hline \end{array}$ | $\begin{array}{r} 100 \\ 50 \\ 40 \\ \hline \end{array}$ | $\begin{array}{r} 200 \\ 100 \\ 80 \\ \hline \end{array}$ | ns |
| Input Capacitance, $\mathrm{CIN}_{\text {IN }}$ | Any Input |  | 5 | 7.5 | pF |



Fig. 8-Typical dynamic power dissipation as a function of clock input frequency /see Fig. 9-dynamic power dissipation test circuit).


Fig. 9 - Dynamic power dissipation test circuit.


Fig. 10-Input current test circuit.


Fig. 11 - Input-voltage test circuit.


Fig. 12 - Quiescent-device-current test circuit.


Fig. 13- Typical speed characteristics of o 12-bit comparator.

## TERMINAL ASSIGNMENT




Dimensions in parantheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mi/s $\left(10^{-3}\right.$ inch $)$.

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7703702EA | ACTIVE | CDIP | J | 16 | 1 | None | Call TI | Level-NC-NC-NC |
| CD4585BE | ACTIVE | PDIP | N | 16 | 25 | Pb-Free <br> (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| CD4585BF3A | ACTIVE | CDIP | J | 16 | 1 | None | Call TI | Level-NC-NC-NC |
| CD4585BNSR | ACTIVE | SO | NS | 16 | 2000 | Pb-Free <br> (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR <br> Level-1-235C-UNLIM |
| CD4585BPW | ACTIVE | TSSOP | PW | 16 | 90 | Pb-Free <br> (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |
| CD4585BPWR | ACTIVE | TSSOP | PW | 16 | 2000 | Pb-Free <br> (RoHS) | CU NIPDAU | Level-1-250C-UNLIM |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
None: Not yet available Lead (Pb-Free).
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS \& no $\mathbf{S b} / \mathbf{B r}$ ): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine $(\mathrm{Br})$ or antimony $(\mathrm{Sb})$ above $0.1 \%$ of total product weight.
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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| DIM PINS ** | 14 | 16 | 18 | 20 |
| :---: | :---: | :---: | :---: | :---: |
| A | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC | 0.300 <br> $(7,62)$ <br> BSC |
| B MAX | 0.785 <br> $(19,94)$ | .840 <br> $(21,34)$ | 0.960 <br> $(24,38)$ | 1.060 <br> $(26,92)$ |
| B MIN | - | - | - | - |
| C MAX | 0.300 <br> $(7,62)$ | 0.300 <br> $(7,62)$ | 0.310 <br> $(7,87)$ | 0.300 <br> $(7,62)$ |
| C MIN | 0.245 <br> $(6,22)$ | 0.245 <br> $(6,22)$ | 0.220 <br> $(5,59)$ | 0.245 <br> $(6,22)$ |



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)
PLASTIC DUAL-IN-LINE PACKAGE
16 PINS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C) Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D The 20 pin end lead shoulder width is a vendor option, either half or full width.

NS (R-PDSO-G**)
14-PINS SHOWN


| DIM PINS ** | 14 | 16 | 20 | 24 |
| :---: | :---: | :---: | :---: | :---: |
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.


| PIMS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

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